

# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	2,250	W	8/20µs (Note 7)
Peak Pulse Current	IPP	90	А	8/20µs (Note 7)
ESD Protection – Contact Discharge	$V_{ESD\_Contact}$	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	$V_{ESD\_Air}$	±30	kV	Standard IEC 61000-4-2

### **Thermal Characteristics**

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Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	300	mW
Thermal Resistance, Junction to Ambient $T_A = +25^{\circ}C$	R <sub>0JA</sub>	417	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-55 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

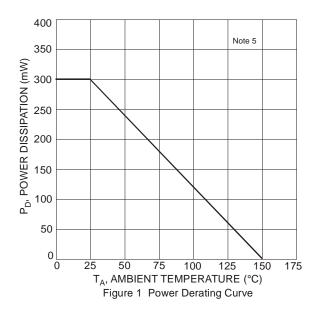
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V <sub>RWM</sub>		_	15	V	—
Channel Leakage Current (Note 6)	I <sub>R</sub>		—	200	nA	V <sub>R</sub> = 15V
Forward Voltage	VF	0.6	0.8	1.2	V	$I_R = 10 \text{mA}$
Reverse Breakdown Voltage	V <sub>BR</sub>	15.5	—		V	$I_R = 1mA$
			—	18	V	$I_{PP} = 1A, t_P = 8/20 \mu s$
Clamping Voltage, Positive Transients (Note 7)	Vc	—	—	20	V	I <sub>PP</sub> = 10A, t <sub>P</sub> = 8/20µs
			—	25	V	$I_{PP} = 90A, t_P = 8/20\mu s$
Channel Input Capacitance (Note 8)	Ст		700		pF	$V_R = 0V$ , f = 1MHz

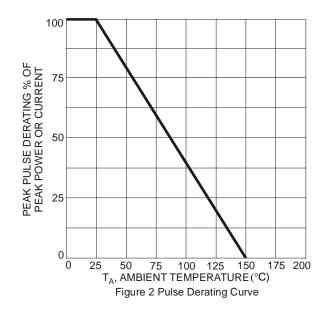
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.

6. Short duration pulse test used to minimize self-heating effect.

7. Clamping voltage value is based on an  $8x20\mu s$  peak pulse current (I<sub>PP</sub>) waveform.

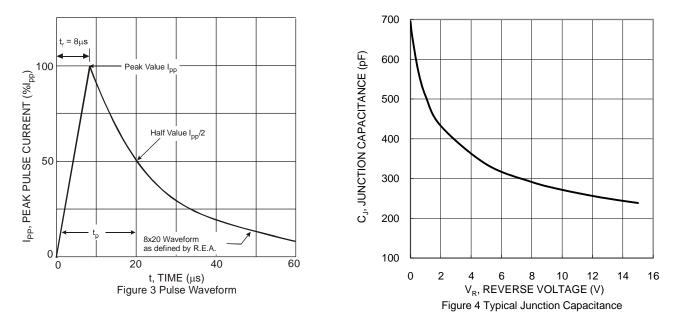
8. Measured from any I/O to GND.





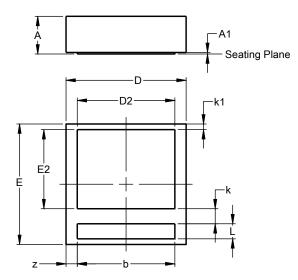


## D15V0H1U2LP16



## Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



### U-DFN1616-2

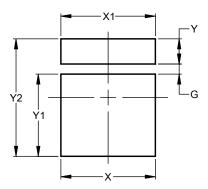
U-DFN1616-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0.00	0.05	0.02		
b	1.25	1.35	1.30		
D	1.55	1.65	1.60		
D2	1.20	1.40	1.30		
E	1.55	1.65	1.60		
E2	0.95	1.15	1.05		
k	0.20 BSC				
k1	0.075 BSC				
L	0.15	0.25	0.20		
z	0.15 BSC				
All	All Dimensions in mm				



### Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN1616-2



Dimensions	Value (in mm)
G	0.150
Х	1.400
X1	1.400
Y	0.375
Y1	1.225
Y2	1.750

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